

# K618

2U Passive Heat Sink

**PRODUCT SPECIFICATIONS**

## Model Number: K618

- Recommend for Intel® CPU as following
  - Intel® Xeon® Processor E3 v4 Family, Socket FCLGA 1150
  - Intel® Xeon® E Processor/Intel Core™ i7 Processor, Socket FCLGA 1151;
  - Intel® Xeon® Processor E3 Family/Intel Core™ i5 Processor, Socket LGA 1155;
  - Intel® Xeon® processor X3400, Socket LGA 1156;
  - Intel® Core™ i9 Processor, Socket FCLGA 1200;
- Passive Heat Sink for 2U Server

## Overall Specification

Dimension	90 x 90 x 66.0 mm
Weight	490 g
Material	Copper Base with Aluminum Stacked Fin plus 3 Heat Pipes
Back Strip	Included
Thermal Grease	Pre-Printed with GE-Toshiba TIG830SP
TDP	Support 125 Watts CPU Power Heat Dissipation

## Performance Chart: K618 Thermal Resistance Thermal Performance vs. Airflow

